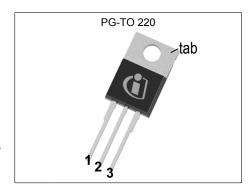
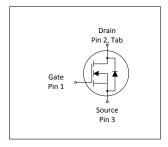


MOSFET

600V CoolMOS™ CFD7 Power Transistor

CoolMOSTM is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies. The latest CoolMOSTM CFD7 is the successor to the CoolMOSTM CFD2 series and is an optimized platform tailored to target soft switching applications such as phase-shift full-bridge (ZVS) and LLC. Resulting from reduced gate charge (Qg), best-in-class reverse recovery charge (Qrr) and improved turn off behavior CoolMOSTM CFD7 offers highest efficiency in resonant topologies. As part of Infineon's fast body diode portfolio, this new product series blends all advantages of a fast switching technology together with superior hard commutation robustness, without sacrificing easy implementation in the design-in process. The CoolMOSTM CFD7 technology meets highest efficiency and reliability standards and furthermore supports high power density solutions. Altogether, CoolMOSTM CFD7 makes resonant switching topologies more efficient, more reliable, lighter and cooler.











Features

- Ultra-fast body diode
- Low gate charge
- Best-in-class reverse recovery charge (Q_{rr})
- Improved MOSFET reverse diode dv/dt and di_F/dt ruggedness
- Lowest FOM R_{DS(on)}*Q_g and R_{DS(on)}*E_{oss}
- Best-in-class R_{DS(on)} in SMD and THD packages

Benefits

- Excellent hard commutation ruggedness
- Highest reliability for resonant topologies
- Highest efficiency with outstanding ease-of-use / performance tradeoff
- Enabling increased power density solutions

Potential applications

Suiteable for Soft Switching topologies Optimized for phase-shift full-bridge (ZVS), LLC Applications – Server, Telecom, EV Charging

Product Validation: Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.

Table 1 Key Performance Parameters

rabio i regi circimano i arametere							
Parameter	Value	Unit					
V _{DS} @ T _{j,max}	650	V					
R _{DS(on),max}	70	mΩ					
$Q_{g,typ}$	67	nC					
I _{D,pulse}	129	A					
E _{oss} @ 400V	7.7	μJ					
Body diode di _F /dt	1300	A/µs					

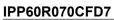
Type / Ordering Code	Package	Marking	Related Links
IPP60R070CFD7	PG-TO 220-3	60R070F7	see Appendix A

600V CoolMOS™ CFD7 Power Transistor IPP60R070CFD7



Table of Contents

Description
Maximum ratings
Thermal characteristics
Electrical characteristics
Electrical characteristics diagrams
Test Circuits
Package Outlines
Appendix A
Revision History
Trademarks
Disclaimer





1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 Maximum ratings

Davamastan	Or made at		Value	s	Unit		
Parameter	Symbol	Min.	Тур.	Max.		Note / Test Condition	
Continuous drain current ¹⁾	I _D	-	-	31 20	А	T _C =25°C T _C =100°C	
Pulsed drain current ²⁾	I _{D,pulse}	-	-	129	Α	T _C =25°C	
Avalanche energy, single pulse	E _{AS}	-	-	151	mJ	I _D =6.3A; V _{DD} =50V; see table 10	
Avalanche energy, repetitive	E AR	-	-	0.76	mJ	I _D =6.3A; V _{DD} =50V; see table 10	
Avalanche current, single pulse	I _{AS}	-	-	6.3	Α	-	
MOSFET dv/dt ruggedness	dv/dt	-	-	120	V/ns	V _{DS} =0400V	
Gate source voltage (static)	V _{GS}	-20	-	20	V	static;	
Gate source voltage (dynamic)	V _{GS}	-30	-	30	V	AC (f>1 Hz)	
Power dissipation	P _{tot}	-	-	156	W	<i>T</i> _C =25°C	
Storage temperature	$T_{ m stg}$	-55	-	150	°C	-	
Operating junction temperature	T _j	-55	-	150	°C	-	
Mounting torque	-	-	-	60	Ncm	M3 and M3.5 screws	
Continuous diode forward current	Is	-	-	31	Α	<i>T</i> _C =25°C	
Diode pulse current ²⁾	I _{S,pulse}	-	-	129	Α	<i>T</i> _C =25°C	
Reverse diode dv/dt ³⁾	dv/dt	-	-	70	V/ns	$V_{\rm DS}$ =0400V, $I_{\rm SD}$ <=31A, $T_{\rm j}$ =25°C see table 8	
Maximum diode commutation speed	di₅/dt	-	-	1300	A/μs	$V_{\rm DS}$ =0400V, $I_{\rm SD}$ <=31A, $T_{\rm j}$ =25°0 see table 8	
Insulation withstand voltage	V _{ISO}	-	-	n.a.	V	V _{rms} , T _C =25°C, t=1min	

 $^{^{1)}}$ Limited by $T_{j,max}.$ $^{2)}$ Pulse width t_p limited by $T_{j,max}$ $^{3)}$ Identical low side and high side switch with identical $R_{\rm G}$

IPP60R070CFD7



2 Thermal characteristics

Table 3 Thermal characteristics

Davamatav	Symbol	Values			I Imit	Nata / Tant Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	8.0	°C/W	-
Thermal resistance, junction - ambient		-	-	62	°C/W	leaded
Thermal resistance, junction - ambient for SMD version	R_{thJA}	-	-	-	°C/W	n.a.
Soldering temperature, wave- & reflow soldering allowed	T_{sold}	-	-	260	°C	1.6mm (0.063 in.) from case for 10s

600V CoolMOS™ CFD7 Power Transistor IPP60R070CFD7



Electrical characteristics

at T_j=25°C, unless otherwise specified

Table 4 **Static characteristics**

Developed	Oh o.l		Values			Note / Tool Openition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	600	-	-	V	V_{GS} =0V, I_D =1mA
Gate threshold voltage	V _{(GS)th}	3.5	4	4.5	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=0.76{\rm mA}$
Zero gate voltage drain current ¹⁾	I _{DSS}	-	- 15	1 63	μΑ	V _{DS} =600V, V _{GS} =0V, T _j =25°C V _{DS} =600V, V _{GS} =0V, T _j =125°C
Gate-source leakage current	I _{GSS}	-	-	100	nA	V _{GS} =20V, V _{DS} =0V
Drain-source on-state resistance	R _{DS(on)}	-	0.057 0.129	0.07	Ω	V _{GS} =10V, I _D =15.1A, T _j =25°C V _{GS} =10V, I _D =15.1A, T _j =150°C
Gate resistance	R _G	-	5.9	-	Ω	f=1MHz, open drain

Dynamic characteristics Table 5

Parameter	Ol		Values			Nata / Tank One differen
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	2721	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz
Output capacitance	Coss	-	53	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz
Effective output capacitance, energy related ²⁾	C _{o(er)}	-	96	-	pF	V _{GS} =0V, V _{DS} =0400V
Effective output capacitance, time related ³⁾	C _{o(tr)}	-	990	-	pF	I _D =constant, V _{GS} =0V, V _{DS} =0400V
Turn-on delay time	t _{d(on)}	-	26	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =10V, $I_{\rm D}$ =11.0A, $R_{\rm G}$ =5.3 Ω ; see table 9
Rise time	t _r	-	23	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =10V, $I_{\rm D}$ =11.0A, $R_{\rm G}$ =5.3 Ω ; see table 9
Turn-off delay time	$t_{ m d(off)}$	-	99	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =10V, $I_{\rm D}$ =11.0A, $R_{\rm G}$ =5.3 Ω ; see table 9
Fall time	t _f	-	6	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =10V, $I_{\rm D}$ =11.0A, $R_{\rm G}$ =5.3 Ω ; see table 9

Table 6 **Gate charge characteristics**

Damamatan	Cyrrah al		Values			Nata / Tant Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	15	-	nC	V_{DD} =400V, I_{D} =11.0A, V_{GS} =0 to 10V
Gate to drain charge	$Q_{ m gd}$	-	23	-	nC	V_{DD} =400V, I_{D} =11.0A, V_{GS} =0 to 10V
Gate charge total	Qg	-	67	-	nC	V _{DD} =400V, I _D =11.0A, V _{GS} =0 to 10V
Gate plateau voltage	$V_{ m plateau}$	-	5.5	-	V	V _{DD} =400V, I _D =11.0A, V _{GS} =0 to 10V

 $^{^{1)}}$ Maximum specification is defined by calculated six sigma upper confidence bound $^{2)}$ $C_{\rm o(er)}$ is a fixed capacitance that gives the same stored energy as $C_{\rm oss}$ while $V_{\rm DS}$ is rising from 0 to 400V $^{3)}$ $C_{\rm o(tr)}$ is a fixed capacitance that gives the same charging time as $C_{\rm oss}$ while $V_{\rm DS}$ is rising from 0 to 400V

IPP60R070CFD7

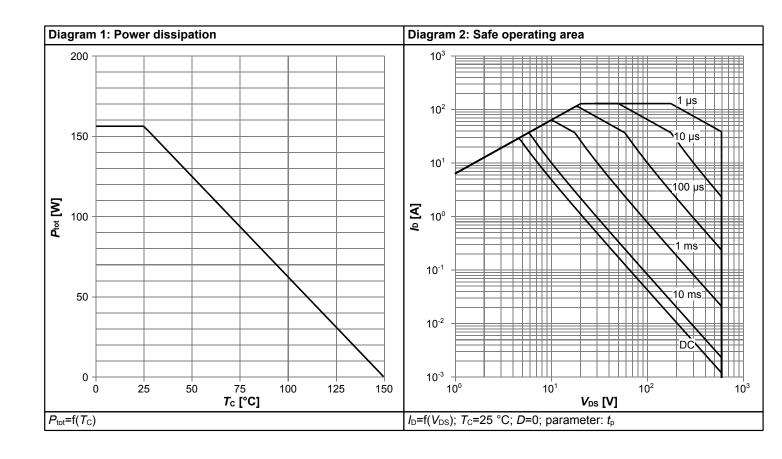


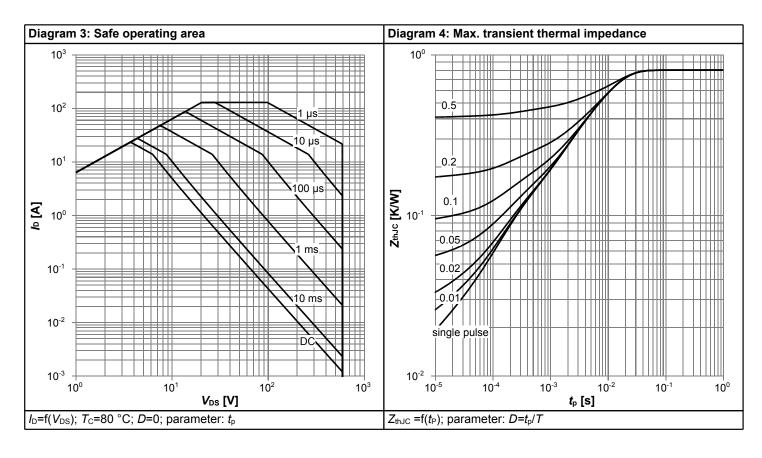
Table 7 Reverse diode characteristics

Devementer	Cymphal	Values			Unit	Nata / Tast Canditian
Parameter	Symbol	Min.	Тур.	Max.	Ullit	Note / Test Condition
Diode forward voltage	V _{SD}	-	1.0	-	V	V _{GS} =0V, I _F =15.1A, T _j =25°C
Reverse recovery time	t _{rr}	-	124	186	ns	V_R =400V, I_F =11A, di_F/dt =100A/ μ s; see table 8
Reverse recovery charge	Q _{rr}	-	0.57	1.14	μC	V_R =400V, I_F =11A, di_F/dt =100A/ μ s; see table 8
Peak reverse recovery current	I _{rrm}	_	7.8	-	А	V_R =400V, I_F =11A, di_F/dt =100A/ μ s; see table 8

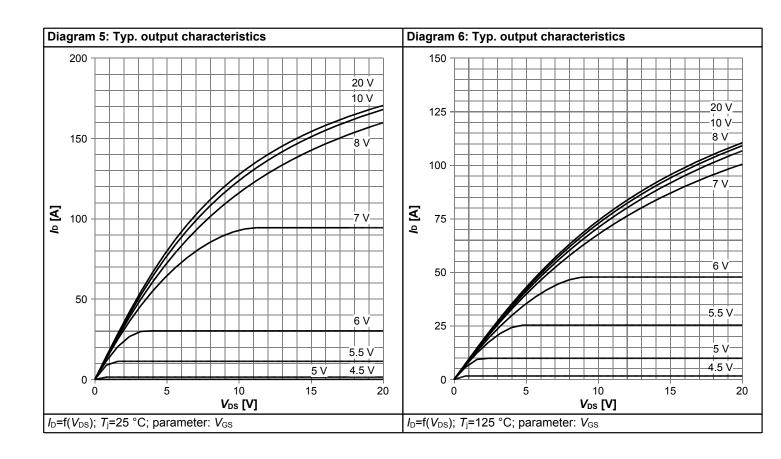


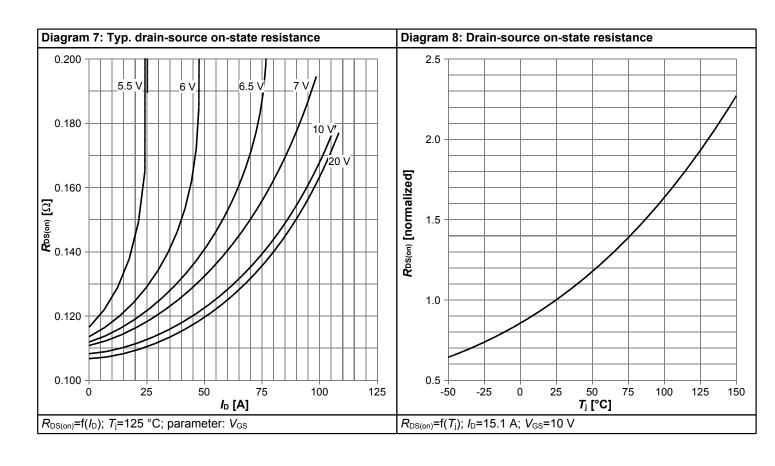
4 Electrical characteristics diagrams



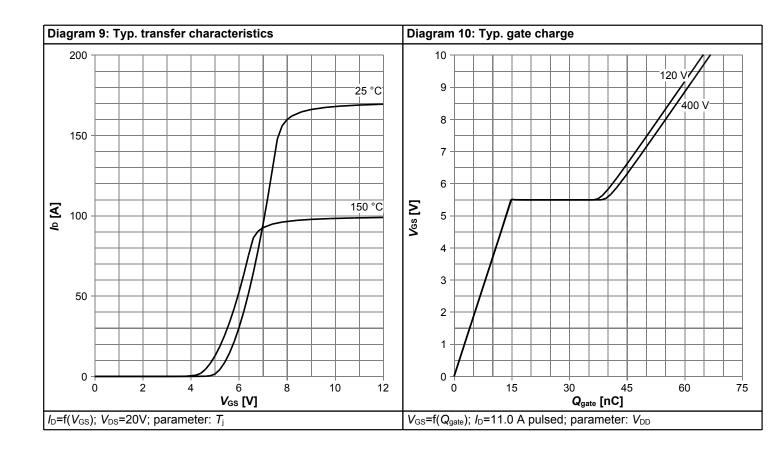


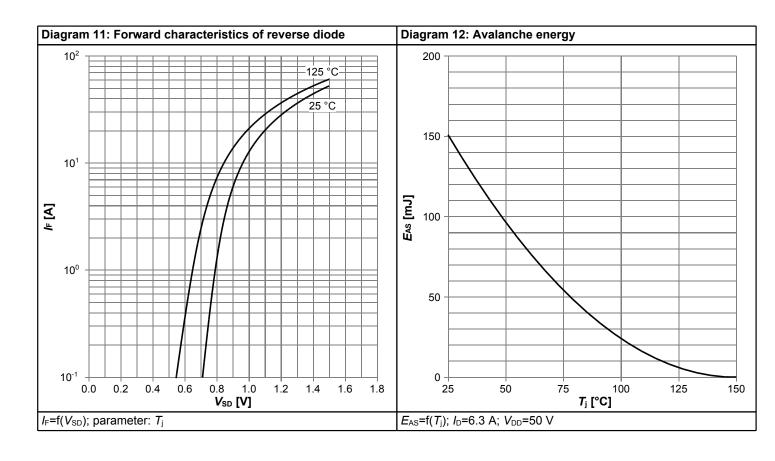




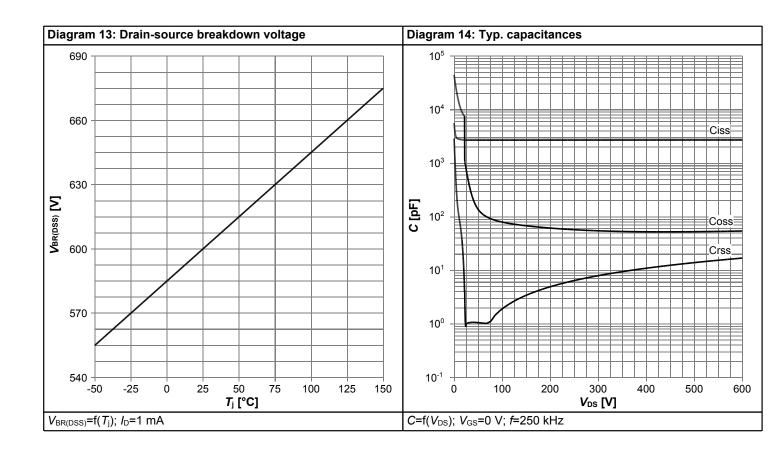


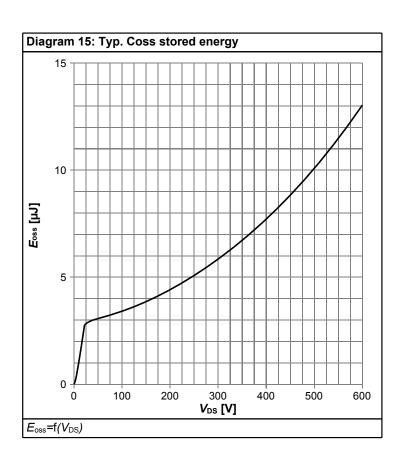














5 Test Circuits

Table 8 Diode characteristics

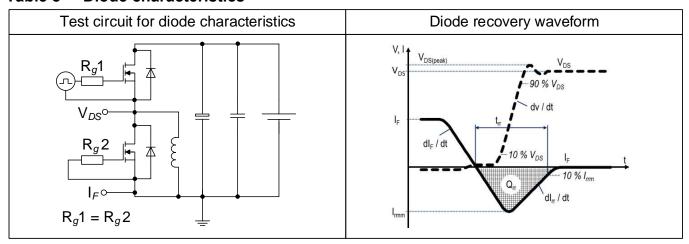
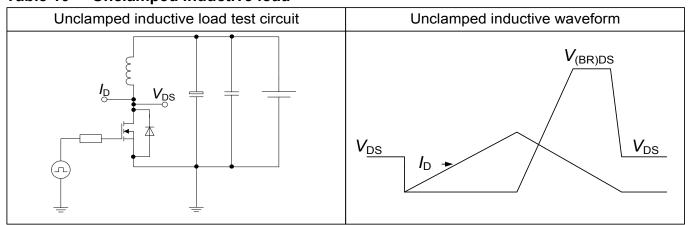


Table 9 Switching times



Table 10 Unclamped inductive load





6 Package Outlines

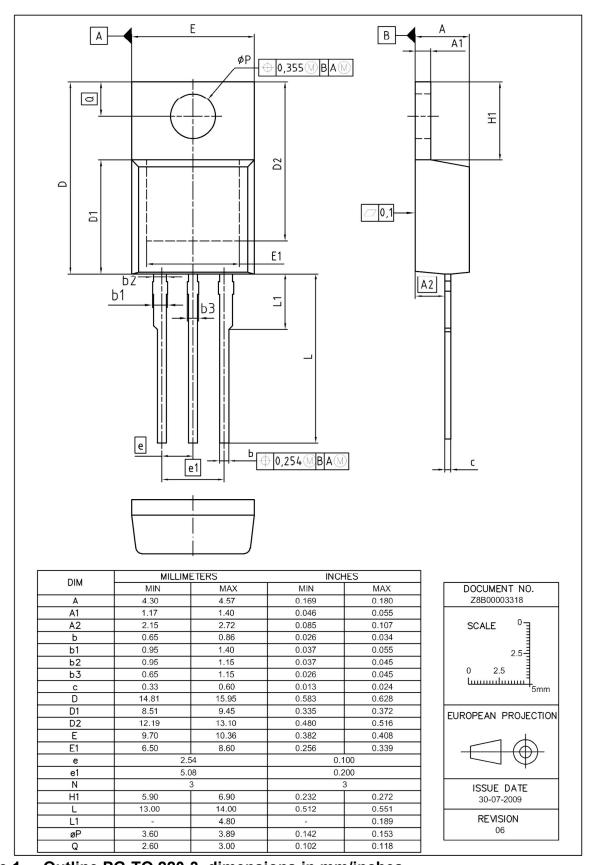


Figure 1 Outline PG-TO 220-3, dimensions in mm/inches

600V CoolMOS™ CFD7 Power Transistor IPP60R070CFD7



7 Appendix A

Table 11 Related Links

• IFX CoolMOS CFD7 Webpage: www.infineon.com

• IFX CoolMOS CFD7 application note: www.infineon.com

• IFX CoolMOS CFD7 simulation model: www.infineon.com

• IFX Design tools: www.infineon.com





Revision History

IPP60R070CFD7

Revision: 2018-01-18, Rev. 2.1

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2017-08-25	Release of final version
2.1	2018-01-18	Raised diode current for dv/dt and dif/dt (table 2) to value of continuous drain current; Changed internal Rg (table 4); Renamed related links (table 11)

Trademarks of Infineon Technologies AG

AURIX™, C166™, CanPAK™, CIPOS™, CoolGaN™, CoolMOS™, CoolSeT™, CoolSiC™, CORECONTROL™, CROSSAVE™, DAVE™, DI-POL™, DrBlade™, EasyPIM™, EconoBRIDGE™, EconoPUAL™, EconoPIM™, EiceDRIVER™, eupec™, FCOS™, HITFET™, HybridPACK™, Infineon™, ISOFACE™, IsoPACK™, i-Wafer™, MIPAQ™, ModSTACK™, my-d™, NovalithIC™, OmniTune™, OPTIGA™, OptiMOS™, ORIGA™, POWERCODE™, PRIMARION™, PrimePACK™, PrimeSTACK™, PROFET™, PRO-SIL™, RASIC™, REAL3™, ReverSave™, SatRIC™, SIEGET™, SIPMOS™, SmartLEWIS™, SOLID FLASH™, SPOC™, TEMPFET™, thinQ!™, TRENCHSTOP™, TriCore™.

Trademarks updated August 2015

Other Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

We Listen to Your Comments

Any information within this document that you feel is wrong, unclear or missing at all? Your feedback will help us to continuously improve the quality of this document. Please send your proposal (including a reference to this document) to: erratum@infineon.com

Published by Infineon Technologies AG 81726 München, Germany © 2018 Infineon Technologies AG All Rights Reserved.

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office (www.infineon.com).

Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

The Infineon Technologies component described in this Data Sheet may be used in life-support devices or systems and/or automotive, aviation and aerospace applications or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support, automotive, aviation and aerospace device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.